# **SSL2103**

# SMPS controller IC for dimmable LED lighting

Rev. 2 — 25 November 2010

**Product data sheet** 

# 1. General description

SSL2103 is a Switched Mode Power Supply (SMPS) controller IC designed for LED lighting applications. It is an extension of the NXP SSL2101/SSL2102 product platform, allowing easy design of derivative applications.

When used in combination with a phase cut dimmer connected directly to a rectified mains, it provides dimmability to the application.

In dimmer applications, integrated dedicated circuitry optimizes the dimming curve.

- SSL2101: fully integrated LED driver for lamps up to 10 W
- SSL2102: fully integrated LED driver for lamps up to 25 W
- SSL2103: gives the application designer flexibility permitting the:
  - control of an external power switch to allow the IC to provide any power
  - control of external bleeder transistors to provide extended dimmer interoperability

The device includes a circuit that allows start-up directly from the rectified mains voltage.

### 2. Features and benefits

- Easy migration to existing lighting control infrastructures, TRIAC and transistor dimmers
- Compatible with most dimming solutions
- Optimized efficiency with valley switching managed by built-in circuitry
- Built-in demagnetization detection
- Built-in OverTemperature Protection (OTP)
- Short-Winding Protection (SWP) and OverCurrent Protection (OCP)
- Internal V<sub>CC</sub> generation allowing start-up from rectified mains voltage
- Natural dimming curve by logarithmic correction, optimized for human eye response, down to 1 %

# 3. Applications

The SSL2103 is suitable for various power requirements including:

- Retro-fit lamps
- LED modules such as LED spots and down-lights
- LED strings suitable for retail displays etc.



# **SMPS** controller IC for dimmable LED lighting

# 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage	$V_{DRAIN} > 60 \text{ V}$	<u>[1]</u> 12	20	28	V
f <sub>osc</sub>	oscillator frequency		10	100	130	kHz
I <sub>DRAIN</sub>	current on pin DRAIN	V <sub>DRAIN</sub> > 60 V; with auxiliary supply	-	30	125	μΑ
$\delta_{\text{min}}$	minimum duty factor		-	0	-	%
$\delta_{\text{max}}$	maximum duty cycle	PWMLIMIT= 3 V	-	75	-	%
T <sub>amb</sub>	ambient temperature		-40	-	+100	°C

<sup>[1]</sup>  $V_{CC} = 20 \text{ V}$  minimum to meet all characteristics.

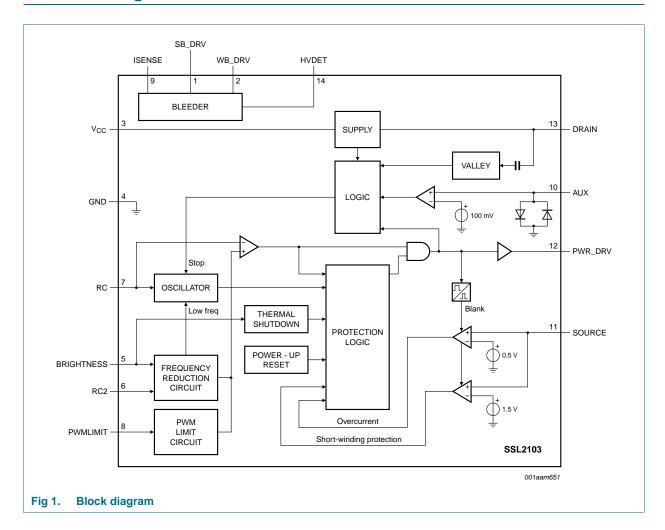
# 5. Ordering information

Table 2. Ordering information

Type number	Package	Package			
	Name	Description	Version		
SSL2103T	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1		

# SMPS controller IC for dimmable LED lighting

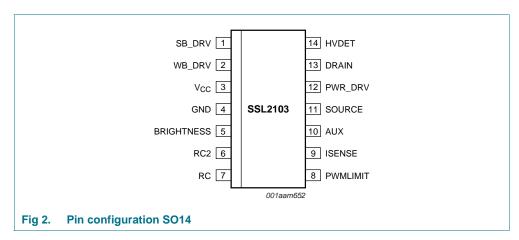
# 6. Block diagram



# **SMPS** controller IC for dimmable LED lighting

# 7. Pinning information

# 7.1 Pinning



# 7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
SB_DRV	1	strong bleeder switch drive
WB_DRV	2	weak bleeder switch drive
V <sub>CC</sub>	3	supply voltage
GND	4	ground
BRIGHTNESS	5	brightness input
RC2	6	setting for frequency reduction
RC	7	frequency setting
PWMLIMIT	8	PWM limit input
ISENSE	9	current sense input for WBLEED
AUX	10	input for voltage from auxiliary winding for timing (demagnetization)
SOURCE	11	current sense input of external power switch
PWR_DRV	12	power switch drive
DRAIN	13	drain of external power switch; input for start-up current and valley sensing
HVDET	14	input for high voltage sensing

#### SMPS controller IC for dimmable LED lighting

# 8. Functional description

The SSL2103 is a LED driver IC that operates directly from the rectified mains. The SSL2103 uses on-time mode control and frequency control to control the LED brightness. The BRIGHTNESS and PWMLIMIT input of the IC can be used to control the LED light output in combination with an external dimmer. The PWMLIMIT input can also be used for Thermal Lumen Management (TLM) and for precision LED current control.

### 8.1 Start-up and Under Voltage Lock Out (UVLO)

Initially, the IC is self-supplying from the rectified mains voltage. The IC starts switching as soon as the voltage on pin  $V_{CC}$  passes the  $V_{CC(startup)}$  level. The supply can be taken over by the auxiliary winding of the transformer as soon as  $V_{CC}$  is high enough and the supply from the line is stopped for high efficiency operation. Alternatively the IC can be supplied via a bleeder resistor connected to a high voltage.

**Remark:** The maximum V<sub>CC</sub> voltage rating of the IC must be considered.

#### 8.2 Oscillator

An oscillator inside the IC provides the timing for the switching converter logic.

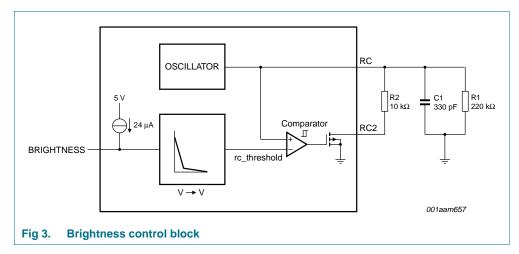
The frequency of the oscillator is set by the external resistors and the capacitor on pin RC and pin RC2. The external capacitor is charged rapidly to the  $V_{RC(max)}$  level and, starting from a new primary stroke, discharges to the  $V_{RC(min)}$  level. Because the discharge is exponential, the relative sensitivity of the duty factor to the regulation voltage at low duty factor, is almost equal to the sensitivity at high duty factors. This results in a more constant gain over the duty factor range, compared to Pulse Width Modulated (PWM) systems with a linear sawtooth oscillator. Stable operation at low duty factors is easily achieved. The frequency of the converter when  $V_{BRIGHTNESS}$  is high can be calculated using Equation 1:

$$RC = \frac{1}{3.5} \cdot \left( \frac{1}{f_{osc}} - t_{charge} \right) \tag{1}$$

R equals the parallel resistance of both oscillator resistors. C is the capacitor connected at the RC pin (pin 7).

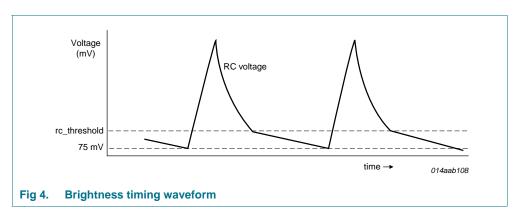
The BRIGHTNESS input controls the frequency reduction mode. <u>Figure 3</u> shows that the oscillator switches over from an RC curve with R1/R2, to R1 only. A low BRIGHTNESS voltage will reduce the switching frequency.

#### SMPS controller IC for dimmable LED lighting



A typical RC waveform is shown in <u>Figure 4</u>. The RC switch-over threshold is controlled by the BRIGHTNESS pin.

To ensure that the capacitor can be charged within the charge time, the value of the oscillator capacitor should be limited to 1 nF. Due to leakage current, the value of the resistor connected between the RC pin and the ground should be limited to a maximum of  $220~\mathrm{k}\Omega$ .



### 8.3 Duty factor control

The duty factor is controlled by an internally regulated voltage and the oscillator signal on pin RC. The internal regulation voltage is set by the voltage on the PWMLIMIT pin.

A low PWMLIMIT voltage will results in a low on-time for the external power switch. The minimum duty factor of the switched mode power supply can be set to 0%. The maximum duty factor is set to 75%.

### 8.4 Bleeder for dimming applications

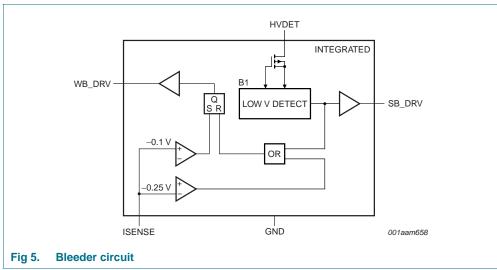
The SSL2103 IC contains some circuitry intended for mains dimmer compatibility. This circuitry can drive two external current sinks, called bleeders. A strong bleeder is used for zero-cross reset of the dimmer and TRIAC latching. A weak bleeder is added to maintain the hold current through the dimmer.

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The SB\_DRV output is activated when the maximum voltage on pin HVDET is below the  $V_{th(SBLEED)}$  level (52 V typically). The WB\_DRV output is activated as soon as the voltage on pin ISENSE exceeds the  $V_{th(high)(ISENSE)}$  level (–100 mV typically). The WB\_DRV output is deactivated when the ISENSE voltage drops below the  $V_{th(low)(ISENSE)}$  level (–250 mV typically). The WB\_DRV output is also deactivated when the strong bleeder switch is switched on. See Figure 5.



#### 8.5 Valley switching

A new cycle is started when the primary switch is switched on (see <u>Figure 6</u>). After a time determined by the oscillator voltage, RC and the internal regulation level, the switch is turned off and the secondary stroke starts. The internal regulation level is determined by the voltage on pin PWMLIMIT.

After the secondary stroke, the drain voltage shows an oscillation with a frequency of approximately:

$$\frac{1}{2 \times \pi \times \sqrt{(L_p \times C_p)}}\tag{2}$$

where:

L<sub>D</sub> = primary self inductance

C<sub>p</sub> = parasitic capacitance on drain node

As soon as the oscillator voltage is high again and the secondary stroke has ended, the circuit waits for a low drain voltage before starting a new primary stroke.

<u>Figure 6</u> shows the drain voltage together with the valley signal, the signal indicating the secondary stroke and the RC voltage.

The primary stroke starts some time before the actual valley at low ringing frequencies, and some time after the actual valley at high ringing frequencies.

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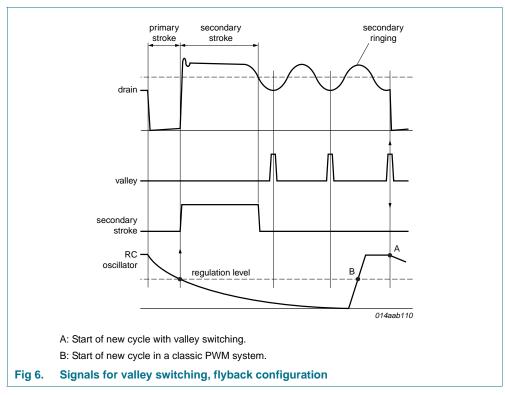
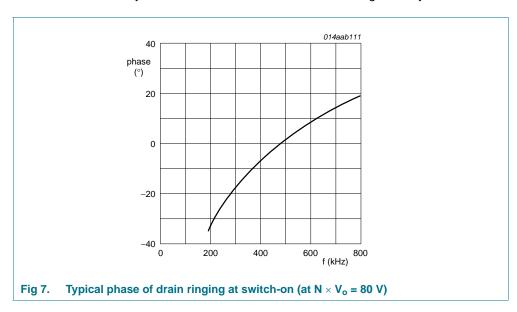


Figure 7 shows a typical curve for a reflected output voltage N at an output voltage of 80 V. This voltage is the output voltage transferred to the primary side of the transformer with the factor N (determined by the turns ratio of the transformer). It shows that the system switches exactly at minimum drain voltage for ringing frequencies of 480 kHz, thus reducing the switch-on losses to a minimum. At 130 kHz, the next primary stroke is started at 33° before the valley. The switch-on losses are still reduced significantly.



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# 8.6 Demagnetization

The system operates in discontinuous conduction mode if the AUX pin is connected. As long as the secondary stroke has not ended, the oscillator will not start a new primary stroke. During the first  $t_{sup(xfmr\_ring)}$  seconds, demagnetization recognition is suppressed. This suppression may be necessary in applications where the transformer has a large leakage inductance and at low output voltages.

### 8.7 Overcurrent protection

The cycle-by-cycle peak drain current limit circuit uses the external source resistor  $R_{SENSE}$  to measure the current. The circuit is activated after the leading edge blanking time  $t_{leb}$ . The protection circuit limits the source voltage over the  $R_{SENSE}^{-1}$  resistor to  $V_{th(ocp)SOURCE}$ , and thus limits the primary peak current.

# 8.8 Short-winding protection

The short-winding protection circuit is also activated after the leading edge blanking time. If the source voltage exceeds the short-winding protection threshold voltage  $V_{th(swp)SOURCE}$ , the IC stops switching. Only a power-on reset will restart normal operation. The short-winding protection also protects in case of a secondary diode short circuit.

### 8.9 Overtemperature protection

Accurate temperature protection is provided in the device. When the junction temperature exceeds the thermal shut-down temperature, the IC stops switching. During thermal protection, the IC current is lowered to the start-up current. The IC continues normal operation as soon as the overtemperature situation has disappeared.

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<sup>1.</sup> R<sub>SENSE</sub> is the resistor between the SOURCE pin and GND

### **SMPS** controller IC for dimmable LED lighting

# 9. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). All voltages are measured with respect to ground; positive currents flow into the device.

Symbol	Parameter	Conditions	М	in	Max	Unit
Voltages						
V <sub>CC</sub>	supply voltage	continuous	<u>[1]</u> _C	0.4	+28	V
$V_{RC}$	voltage on pin RC		[1] _(	).4	+3	V
V <sub>RC2</sub>	voltage on pin RC2		-0	0.4	+3	V
V <sub>BRIGHTNESS</sub>	voltage on pin BRIGHTNESS		-0	).4	+5	V
V <sub>PWMLIMIT</sub>	voltage on pin PWMLIMIT		-0	0.4	+5	V
V <sub>SOURCE</sub>	voltage on pin SOURCE		-0	0.4	+5	V
V <sub>DRAIN</sub>	voltage on pin DRAIN	T <sub>amb</sub> = 25 °C	-0	).4	+600	V
V <sub>HVDET</sub>	voltage on pin HVDET	T <sub>amb</sub> = 25 °C	-0	).4	+600	V
Currents						
I <sub>ISENSE</sub>	current on pin ISENSE		[2] -2	20	+5	mA
I <sub>AUX</sub>	current on pin AUX		<u>[2]</u> _1	10	+5	mA
I <sub>SB_DRV</sub>	current on pin SB_DRV				+3.6	mA
I <sub>WB_DRV</sub>	current on pin WB_DRV				+3.6	mA
General						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 70 °C	-		250	mW
T <sub>stg</sub>	storage temperature		-5	55	+150	°C
T <sub>amb</sub>	ambient temperature		_4	10	+100	°C
Tj	junction temperature		_4	10	+150	°C
V <sub>ESD</sub>	electrostatic discharge voltage	human body model;	[3]			
		Pins 13 and 14	-1	1000	+1000	V
		All other pins	-2	2000	+2000	V
		charged device model	<u>[4]</u> _5	500	+500	V

<sup>[1]</sup> Pins  $V_{CC}$  and RC cannot be current driven.

# 10. Thermal characteristics

#### Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air, on JESD51-3 board	123	K/W
$\Psi_{j-top}$	thermal characterization parameter from junction to top	in free air, on JESD51-3 board	7	K/W

SL2103

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<sup>[2]</sup> Pins ISENSE and AUX cannot be voltage driven.

<sup>[3]</sup> Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k $\Omega$  series resistor.

<sup>[4]</sup> Charged device model: equivalent to charging the IC up to 1 kV and the subsequent discharging of each pin down to 0 V over a 1 Ω resistor.

### SMPS controller IC for dimmable LED lighting

# 11. Characteristics

### Table 6. Characteristics

 $T_{amb}$  = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC;  $V_{CC}$  = 20 V and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Supply							
Icc	supply current	normal operation; bleeders disconnected; V <sub>DRAIN</sub> = 60 V;		-	1.8	-	mA
I <sub>CC(ch)</sub>	charge supply current	$V_{DRAIN} > 60 \text{ V}; V_{CC} = 0 \text{ V}$		-6	-4.5	-	mA
V <sub>CC</sub>	supply voltage	V <sub>DRAIN</sub> > 60 V		12	20	28	V
V <sub>CC(startup)</sub>	start-up supply voltage			-	10.25	-	V
V <sub>CC(UVLO)</sub>	undervoltage lockout supply voltage			-	8.2	-	V
I <sub>DRAIN</sub>	current on pin DRAIN	current on pin DRAIN V <sub>DRAIN</sub> > 60 V; with auxiliary supply -		-	30	125	μΑ
V <sub>DRAIN</sub>	voltage on pin DRAIN			40	-	600	V
Pulse width mod	ulator						
$\delta_{\text{min}}$	minimum duty factor			-	0	-	%
$\delta_{max}$	maximum duty cycle	PWMLIMIT= 3 V		-	75	-	%
SOPS							
V <sub>det(demag)</sub>	demagnetization detection voltage			50	100	150	mV
t <sub>sup(xfmr_ring)</sub>	transformer ringing suppression time	at start of secondary stroke		1.0	1.5	2.0	μS
RC oscillator							
V <sub>RC(min)</sub>	minimum voltage on pin RC			60	75	90	mV
V <sub>RC(max)</sub>	maximum voltage on pin RC			2.4	2.5	2.6	V
t <sub>ch(RC)</sub>	charge time on pin RC			-	1	-	μS
f <sub>osc</sub>	oscillator frequency			10	100	130	kHz
I <sub>BRIGHTNESS</sub>	current on pin BRIGHTNESS	V <sub>BRIGHTNESS</sub> = 0 V		-20	-24	-28	μΑ
Driver bleeder							
V <sub>th(HVDET)</sub>	threshold voltage on pin HVDET			46	52	56	V
$V_{th(low)ISENSE}$	low threshold voltage on pin ISENSE			-	-250	-	mV
$V_{th(high)ISENSE}$	high threshold voltage on pin ISENSE			-	-100	-	mV
I <sub>SB_DRV</sub>	current on pin SB_DRV	V <sub>SB_DRV</sub> < 9 V		-	3.2	3.6	mΑ
I <sub>WB_DRV</sub>	current on pin WB_DRV	$V_{WB\_DRV} < 9 V$		-	3.2	3.6	mA
V <sub>SB_DRV</sub>	voltage on pin SB_DRV	$I_{SB\_DRV} = 0$		-	-	12	V
		$I_{SB\_DRV} = 2.5 \text{ mA}$		10	-	-	٧
		during $V_{CC}$ start-up; $I_{SB\_DRV} = 2.5 \text{ mA}$	[2]	5.5	-	-	V
$V_{WB\_DRV}$	voltage on pin WB_DRV	$I_{WB\_DRV} = 0$		-	-	12	V
		$I_{WB DRV} = 2.5 \text{ mA}$		10			V

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### **SMPS** controller IC for dimmable LED lighting

 Table 6.
 Characteristics ...continued

 $T_{amb}$  = 25 °C; no overtemperature; all voltages are measured with respect to ground; currents are positive when flowing into the IC;  $V_{CC}$  = 20 V and PWMLIMIT and BRIGHTNESS pins are disconnected unless otherwise specified. Typical frequency 100 kHz.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Duty factor regu	ılator: pin PWMLIMIT						
I <sub>PWMLIMIT</sub>	current on pin PWMLIMIT			-25	-	-18	μΑ
V <sub>PWMLIMIT</sub>	voltage on pin PWMLIMIT	maximum duty cycle threshold VBRIGHTNESS = 3 V		-	2.6	-	V
		minimum duty cycle threshold V <sub>BRIGHTNESS</sub> = 3 V		-	0.45	-	V
Valley switching	J						
$(\Delta V/\Delta t)_{vrec}$	valley recognition voltage change with time	minimum absolute value	[3]	-	100	-	V/μs
f <sub>ring</sub>	ringing frequency	N × V <sub>O</sub> = 100 V		200	500	800	kHz
$t_{d(vrec\text{-swon})}$	valley recognition to switch-on delay time			-	150	-	ns
Current and sho	ort circuit winding protection						
$V_{th(ocp)SOURCE}$	overcurrent protection threshold voltage on pin SOURCE	$dV/dt = 0.1 V/\mu s$		0.46	0.50	0.53	V
$V_{\text{th(swp)}}$ SOURCE	short-winding protection threshold voltage on pin SOURCE	$dV/dt = 0.1 V/\mu s$		-	1.5	-	V
$t_{\text{d(ocp-swoff)}}$	delay time from overcurrent protection to switch-off	$dV/dt = 0.5 V/\mu s$		-	160	185	ns
t <sub>leb</sub>	leading edge blanking time			250	350	450	ns
FET driver outp	ut stage						
$V_{O(PWR\_DRV)}$	output Voltage on pin PWR_DRV			-	12	$V_{CC}$	V
$t_{r(PWR\_DRV)}$	rise time on pin PWR_DRV	With maximum input capacitance 4.7 nF on pin PWR_DRV; V <sub>CC</sub> = 20 V		-	210	-	ns
$t_{f(PWR\_DRV)}$	fall time on pin PWR_DRV	With maximum input capacitance 4.7 nF on pin PWR_DRV; V <sub>CC</sub> = 20 V		-	210	-	ns
Temperature pro	otection						
T <sub>otp</sub>	overtemperature protection threshold	junction temperature		150	160	170	°C
$T_{otp(hys)}$	overtemperature protection trip hysteresis	junction temperature		-	7	-	°C

<sup>[1]</sup>  $V_{CC} = 20 \text{ V}$  minimum to meet all characteristics.

<sup>[2]</sup> SB\_DRV is active during V<sub>CC</sub> start-up.

<sup>[3]</sup> Voltage change in time for valley recognition.

# **SMPS** controller IC for dimmable LED lighting

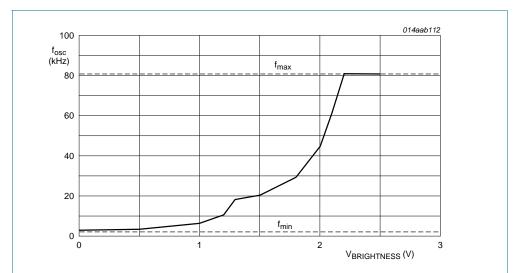


Fig 8. Typical frequency as a function of voltage on pin BRIGHTNESS (with RC value given in Figure 3)

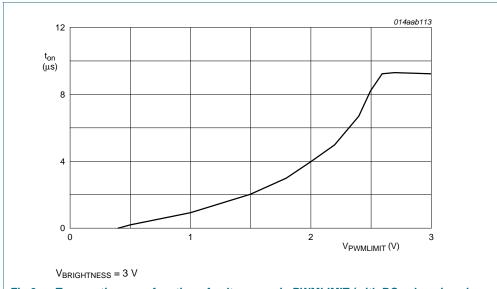
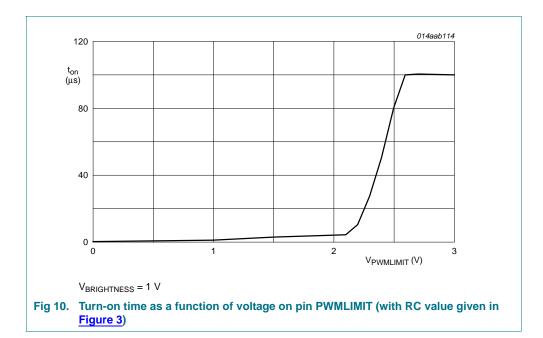


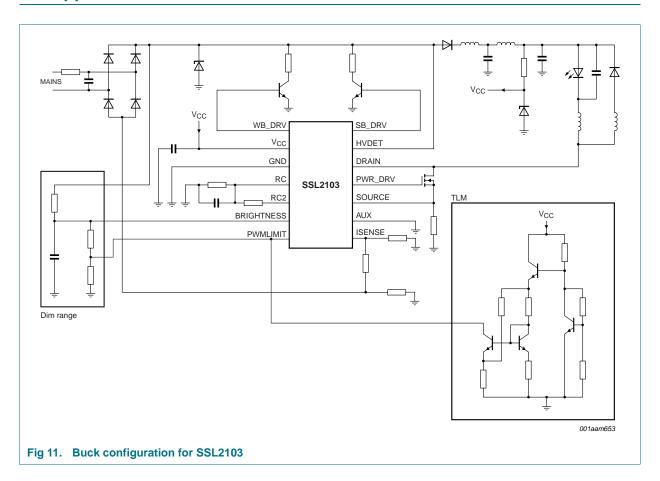
Fig 9. Turn-on time as a function of voltage on pin PWMLIMIT (with RC value given in Figure 3)

# **SMPS** controller IC for dimmable LED lighting

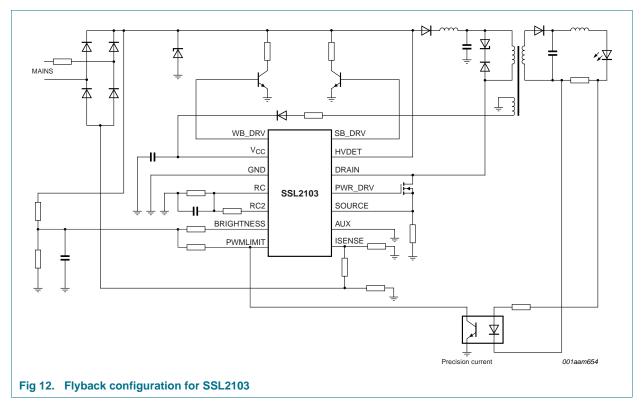


# **SMPS** controller IC for dimmable LED lighting

# 12. Application information



# **SMPS** controller IC for dimmable LED lighting



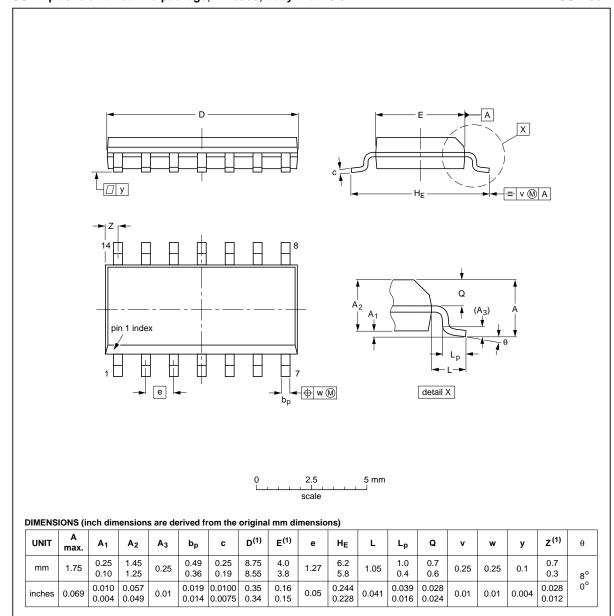
Further application information can be found in the SSL2103 application notes.

### **SMPS** controller IC for dimmable LED lighting

# 13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	1550E DATE	
SOT108-1	076E06	MS-012			<del>99-12-27</del> 03-02-19	

Fig 13. Package outline SOT108-1 (SO14)

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# **SMPS** controller IC for dimmable LED lighting

# 14. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
SSL2103 v.2	20101125	Product data sheet	-	SSL2103 v.1
Modifications:	<ul> <li>Status chan</li> </ul>	ged from Preliminary to Pro	oduct.	
	<ul> <li>Various cha</li> </ul>	nges to content.		
SSL2103 v.1	20101011	Preliminary data sheet	-	-

#### SMPS controller IC for dimmable LED lighting

# 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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### **SMPS** controller IC for dimmable LED lighting

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### SMPS controller IC for dimmable LED lighting

# 17. Contents

1	General description
2	Features and benefits
3	Applications
4	Quick reference data
5	Ordering information
6	Block diagram 3
7	Pinning information 4
7.1	Pinning
7.2	Pin description 4
8	Functional description 5
8.1	Start-up and Under Voltage Lock Out (UVLO) . 5
8.2	Oscillator 5
8.3	Duty factor control 6
8.4	Bleeder for dimming applications 6
8.5	Valley switching
8.6	Demagnetization9
8.7	Overcurrent protection
8.8 8.9	Short-winding protection
	Overtemperature protection
9	Limiting values
10	Thermal characteristics 10
11	Characteristics11
12	Application information
13	Package outline
14	Revision history
15	Legal information
15.1	Data sheet status
15.2	Definitions
15.3	Disclaimers 19
15.4	Trademarks
16	Contact information 20
17	Contents 21

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